

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yasuki YOSHIHISA</td> <td>04/04/2011</td> </tr> <tr> <td>Kikuo KATO</td> <td>04/06/2011</td> </tr> <tr> <td>Tetsuya NITTA</td> <td>03/31/2011</td> </tr> <tr> <td>Kazuma ONISHI</td> <td>04/04/2011</td> </tr> </tbody> </table>		Name	Execution Date	Yasuki YOSHIHISA	04/04/2011	Kikuo KATO	04/06/2011	Tetsuya NITTA	03/31/2011	Kazuma ONISHI	04/04/2011
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<b>RECEIVING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Renesas Electronics Corporation</td> </tr> <tr> <td><b>Street Address:</b></td> <td>1753, Shimonumabe, Nakahara-ku, Kawasaki-shi,</td> </tr> <tr> <td><b>City:</b></td> <td>Kanagawa</td> </tr> <tr> <td><b>State/Country:</b></td> <td>JAPAN</td> </tr> </table>		<b>Name:</b>	Renesas Electronics Corporation	<b>Street Address:</b>	1753, Shimonumabe, Nakahara-ku, Kawasaki-shi,	<b>City:</b>	Kanagawa	<b>State/Country:</b>	JAPAN		
<b>Name:</b>	Renesas Electronics Corporation										
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<b>City:</b>	Kanagawa										
<b>State/Country:</b>	JAPAN										
<b>PROPERTY NUMBERS Total: 1</b>											
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Application Number:	13110630										
<b>CORRESPONDENCE DATA</b>											
<p>Fax Number: (202)756-8087</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 202-756-8000</p> <p>Email: Kadkins@mwe.com</p> <p>Correspondent Name: MCDERMOTT WILL &amp; EMERY LLP</p> <p>Address Line 1: 600 13TH STREET, N.W.</p> <p>Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20005-3096</p>											
<b>ATTORNEY DOCKET NUMBER:</b>	067237-0663										
<b>NAME OF SUBMITTER:</b>	Brian K. Seidleck										
<p>Total Attachments: 2</p> <p>source=0672370663assigntransmittal#page1.tif</p> <p>source=0672370663assignment#page1.tif</p>											

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**PATENT**  
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RECORDATION FORM COVER SHEET		
<b>Docket No.: 067237-0663</b>		
<b>PATENTS ONLY</b>		
To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.		
<b>1. Name of Conveying Party(ies)</b> <b>Yasuki YOSHIHISA, Kikuo KATO, Tetsuya NITTA,</b> <b>Kazuma ONISHI</b>  Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	<b>2. Name and address of receiving party(ies)</b> Name: <b>Renesas Electronics Corporation</b>  Internal Address:  Address: <b>1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan</b>	
<b>3. Nature of Conveyance/Execution Date(s)</b>  Execution Date(s): <b>April 4, 2011; April 6, 2011; March 31, 2011 and April 4, 2011 respectively</b>  <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License		
<b>4. Application or patent number(s):</b> A. Patent Application No(s).	<input checked="" type="checkbox"/> This document is being filed together with a new application. B. Patent No(s).	
<b>5. Name and address to whom correspondence concerning document should be mailed:</b>  Name: <b>MCDERMOTT WILL &amp; EMERY LLP</b> Internal Address:  Street Address: <b>600 13th Street, N.W.</b>  City: <b>Washington,</b> State: <b>DC</b> Zip: <b>20005-3096</b> <b>D.C.</b>  Phone Number: <b>202.756.8000</b> Fax Number: <b>202.756.8087</b> Email Address:	<b>6. Total number of applications and patents involved:</b>  <b>7. Total fee (37 CFR 1.21(h) &amp; 3.41)</b> <b>\$40.00</b> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)	
	<b>8. Payment Information:</b>  a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <b>500417</b> Authorized User Name _____	
<b>9. Signature.</b> <i>Stephen A. Becker</i> <b>Stephen A. Becker 26,527</b> <b>Ref. No. 51, 321</b>		
Name and Registration No. of Person Signing		Date
Signature		Date
Total number of pages including cover sheet, attachments and documents: <b>2</b>		

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# ASSIGNMENT

( 譲 渡 証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## SEMICONDUCTOR DEVICE

invented by me (if only one is named below ) or us (if plural inventors are named below ) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Electronics Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)  
(発明者フルネームサイン)

Date Signed  
(署名日)

1) Yasuki Yoshihisa Yasuki YOSHIHISA

April 4, 2011

2) Kikuo Kato Kikuo KATO

April 6, 2011

3) Tetsuya Nitta Tetsuya NITTA

March 31, 2011

4) Kazuma ONISHI Kazuma ONISHI

April 4, 2011

5) \_\_\_\_\_

6) \_\_\_\_\_

7) \_\_\_\_\_

8) \_\_\_\_\_

9) \_\_\_\_\_

10) \_\_\_\_\_

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RECORDED: 05/18/2011

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